TOSHIBA CMOS Digital Integrated Circuit Silicon Monolithic

# TC74AC20P,TC74AC20F

#### Dual 4-Input NAND Gate

The TC74AC20 is an advanced high speed CMOS 4-INPUT NAND GATE fabricated with silicon gate and double-layer metal wiring C<sup>2</sup>MOS technology.

It achieves the high speed operation similar to equivalent Bipolar Schottky TTL while maintaining the CMOS low power dissipation.

The internal circuit is composed of 3 stages including buffer output, which provide high noise immunity and stable output.

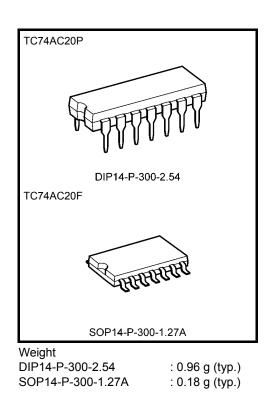
All inputs are equipped with protection circuits against static discharge or transient excess voltage.

#### Features

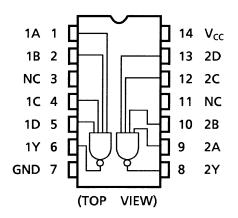
- High speed:  $t_{pd}$  = 4.1 ns (typ.) at V<sub>CC</sub> = 5 V
- Low power dissipation:  $I_{CC} = 4 \mu A \pmod{at Ta} = 25^{\circ}C$
- High noise immunity: V<sub>NIH</sub> = V<sub>NIL</sub> = 28% V<sub>CC</sub> (min)
- Symmetrical output impedance: |I<sub>OH</sub>| = I<sub>OL</sub> = 24 mA (min)

Capability of driving  $50 \Omega$  transmission lines.

- Balanced propagation delays:  $t_{pLH} \simeq t_{pHL}$
- Wide operating voltage range:  $V_{CC}$  (opr) = 2~5.5 V
- Pin and function compatible with 74F20

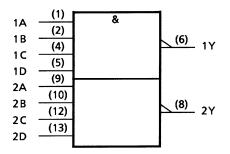


#### **Pin Assignment**



# <u>TOSHIBA</u>

# **IEC Logic Symbol**



# Truth Table

А	В	С	D	Y
L	Х	Х	Х	Н
Х	L	Х	Х	Н
Х	Х	L	Х	Н
Х	Х	Х	L	Н
Н	Н	Н	Н	L

X: Don't care

# Absolute Maximum Ratings (Note 1)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V <sub>CC</sub>	-0.5~7.0	V
DC input voltage	V <sub>IN</sub>	$-0.5 \sim V_{CC} + 0.5$	V
DC output voltage	V <sub>OUT</sub>	$-0.5 \sim V_{CC} + 0.5$	V
Input diode current	I <sub>IK</sub>	±20	mA
Output diode current	IOK	±50	mA
DC output current	IOUT	±50	mA
DC V <sub>CC</sub> /ground current	ICC	±100	mA
Power dissipation	PD	500 (DIP) (Note 2)/180 (SOP)	mW
Storage temperature	T <sub>stg</sub>	-65~150	°C

Note 1: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/Derating Concept and Methods) and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 2: 500 mW in the range of Ta =  $-40 \sim 65^{\circ}$ C. From Ta = 65 to 85°C a derating factor of -10 mW/°C should be applied up to 300 mW.

# **Operating Ranges (Note)**

Characteristics	Symbol	Rating	Unit	
Supply voltage	V <sub>CC</sub>	2.0~5.5	V	
Input voltage	V <sub>IN</sub>	0~V <sub>CC</sub>	V	
Output voltage	V <sub>OUT</sub>	0~V <sub>CC</sub>	V	
Operating temperature	T <sub>opr</sub>	-40~85	°C	
Input rise and fall time	dt/dV	0~100 (V <sub>CC</sub> = $3.3 \pm 0.3$ V)	ns/V	
	u/uv	0~20 (V <sub>CC</sub> = 5 $\pm$ 0.5 V)	115/ V	

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

# **Electrical Characteristics**

#### **DC Characteristics**

Characteristics Symbol		Test Condition		_	Ta = 25°C		Ta = −40~85°C				
				V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit	
		—		2.0	1.50	—	_	1.50	—	v	
High-level input voltage	VIH			3.0	2.10	—	—	2.10	—		
				5.5	3.85	—		3.85	—		
					2.0	_	—	0.50	—	0.50	
Low-level input voltage	V <sub>IL</sub>	—		3.0	—	—	0.90	—	0.90	V	
_					5.5	_		1.65		1.65	
					2.0	1.9	2.0	_	1.9	—	
	V <sub>OH</sub>	V <sub>IN</sub> = V <sub>IH</sub> or V <sub>IL</sub>	I <sub>OH</sub> = -50 μA	3.0	2.9	3.0	_	2.9	—	v	
High-level output				4.5	4.4	4.5		4.4	_		
voltage			$I_{OH} = -4 \text{ mA}$		3.0	2.58	—		2.48	—	v
			I <sub>OH</sub> = -24 mA		4.5	3.94	—		3.80	—	
			I <sub>OH</sub> = -75 mA	(Note)	5.5		_		3.85	_	
	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IH</sub>	I <sub>OL</sub> = 50 μA		2.0	—	0.0	0.1	—	0.1	
				3.0	_	0.0	0.1	—	0.1		
Low-level output voltage					4.5		0.0	0.1	_	0.1	v
			I <sub>OL</sub> = 12 mA I <sub>OL</sub> = 24 mA		3.0	—	—	0.36	0.44	v	
					4.5	—	—	0.36		0.44	
			I <sub>OL</sub> = 75 mA	(Note)	5.5		_	_		1.65	
Input leakage current	IIN	$V_{IN} = V_{CC}$ or GND		5.5	_		±0.1		±1.0	μA	
Quiescent supply current	ICC	$V_{IN} = V_C$	$V_{IN} = V_{CC}$ or GND		5.5		_	4.0	_	40.0	μA

Note: This spec indicates the capability of driving 50  $\Omega$  transmission lines.

One output should be tested at a time for a 10 ms maximum duration.

#### AC Characteristics (C<sub>L</sub> = 50 pF, R<sub>L</sub> = 500 $\Omega$ , input: t<sub>r</sub> = t<sub>f</sub> = 3 ns)

Symbol	Tost Condition	_	Ta = 25°C		Ta = -40~85°C		Unit	
	Test Condition	V <sub>CC</sub> (V)	Min	Тур.	Max	Min	Max	Unit
t <sub>pLH</sub>	—	$3.3\pm 0.3$	_	6.0	10.0	1.0	11.4	ns
t <sub>pHL</sub>		$5.0\pm 0.5$		4.8	7.0	1.0	8.0	
C <sub>IN</sub>	_			5	10	_	10	pF
C <sub>PD</sub> (Note)	_		_	66	_	_	_	pF
	t <sub>pLH</sub> t <sub>pHL</sub> C <sub>IN</sub>	t <sub>pLH</sub> t <sub>pHL</sub> С <sub>IN</sub> С <sub>PD</sub>	tpLH         VCC (V)           tpHL         3.3 ± 0.3           tpHL         5.0 ± 0.5           CIN         —           CPD         —	$\begin{tabular}{ c c c c c c } \hline Symbol & Test Condition & V_{CC} (V) & Min \\ \hline t_{pLH} & & & & & & & \\ \hline t_{pHL} & & & & & & & \\ \hline C_{IN} & & & & & & & & \\ \hline C_{PD} & & & & & & & & \\ \hline \end{array}$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$	$\begin{tabular}{ c c c c c c c c c c c c c c c c c c c$

Note: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load.

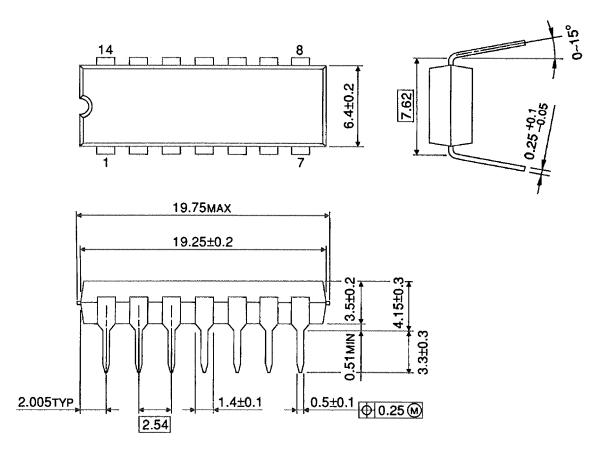
Average operating current can be obtained by the equation:

 $I_{CC}$  (opr) =  $C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2$  (per gate)

#### **Package Dimensions**

DIP14-P-300-2.54

Unit : mm



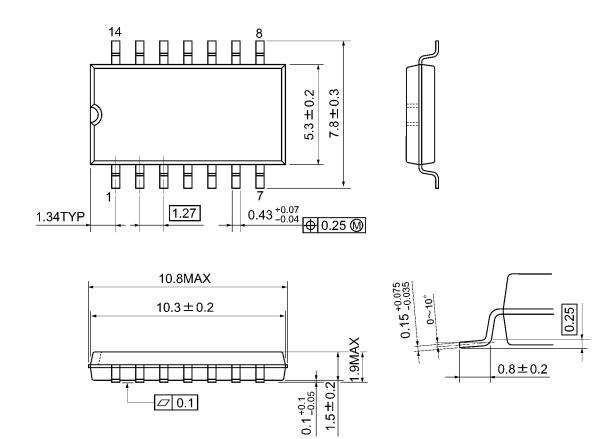
Weight: 0.96 g (typ.)



# **Package Dimensions**

SOP14-P-300-1.27A

Unit: mm



Weight: 0.18 g (typ.)

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